ABSOLUTE MAXIMUM RATINGS

IN to GND0.3V to $\overline{\text{ON}}$, $\overline{\text{FAULT}}$ to GND0.3V to $\overline{\text{SET}}$, $\overline{\text{OUT}}$ to GND0.3V to $\overline{\text{VIN}}$ + Maximum Continuous Short-Circuit Switch Current	0.3V) 2.0A	Operating Temperature Range MAX893LESAStorage Temperature RangeLead Temperature (soldering, 10sec)	65°C to +150°C
SO (derate 5.88mW/°C above +70°C)	71mW		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 3V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
Operating Voltage		2.7		5.5	V	
Quiescent Current	$V_{IN} = 5V$, $\overline{ON} = GND$, $I_{OUT} = 0$		13	20	μΑ	
Off-Supply Current	$\overline{ON} = IN, V_{IN} = V_{OUT} = 5.5V$		0.03	1	μΑ	
Off-Switch Current	$\overline{ON} = IN$, $V_{IN} = 5.5V$, $V_{OUT} = 0$		0.04	15	μΑ	
Undervoltage Lockout	Rising edge, 1% hysteresis	2.0	2.4	2.6	V	
0.00	V _{IN} = 4.5V		70	125	mΩ	
On-Resistance	V _{IN} = 3.0V		88	160		
Current-Limit-Amplifier Threshold	V _{SET} required to turn the switch off (Note 1)	1.178	1.240	1.302	V	
Maximum Programmable Continuous Output Current Limit			1.2		А	
Short-Circuit Current			1.8		А	
I _{OUT} to I _{SET} Current Ratio	I _{OUT} = 500mA, V _{OUT} > 1.6V	920	1080	1250	A/A	
ON Input Voltage Low	V _{IN} = 2.7V to 5.5V			0.8	V	
ON Input Voltage High	V _{IN} = 2.7V to 3.6V	2.0			V	
	V _{IN} = 4.5V to 5.5V	2.4				
ON Input Leakage Current	V _{ON} = 5.5V		0.01	1	μΑ	
I _{SET} Bias Current	V _{SET} = 1.24V, I _{OUT} = 0; V _{IN} = V _{OUT}		0.5	3	μΑ	
FAULT Logic Output Voltage Low	I _{SINK} = 1mA, V _{SET} = 1.4V			0.4	V	
FAULT Logic Output High Leakage Current	VFAULT = 5.5V, VSET = 1V		0.05	1	μΑ	
Slow Current-Loop Response Time	20% current overdrive, V _{IN} = 5V		5		μs	
Fast Current-Loop Response Time			2		μs	
Turn-On Time	V _{IN} = 5V, I _{OUT} = 500mA		80	200	μs	
rum-on nime	V _{IN} = 3V, I _{OUT} = 500mA		115			
Turn-Off Time	V _{IN} = 5V, I _{OUT} = 500mA	2	4		μs	
	1					

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 3V, T_A = -40$ °C to +85°C, unless otherwise noted.) (Note 2)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
Operating Voltage		3.0		5.5	V	
Quiescent Current	$V_{IN} = 5V, \overline{ON} = GND, I_{OUT} = 0$			30	μΑ	
Off-Supply Current	$\overline{ON} = IN, V_{IN} = V_{OUT} = 5.5V$			2.2	μΑ	
Off-Switch Current	$\overline{ON} = IN, V_{IN} = 5.5V, V_{OUT} = 0$			15	μΑ	
Undervoltage Lockout	Rising edge, 1% hysteresis	2.0		2.9	V	
On-Resistance	V _{IN} = 4.5V			125	mΩ	
OH-Hesistance	V _{IN} = 3.0V			160] 11152	
Current-Limit-Amplifier Threshold	V _{SET} required to turn the switch off (Note 1)	1.14		1.34	V	
IOUT to ISET Current Ratio	I _{OUT} = 500mA, V _{OUT} > 1.6V	865		1300	A/A	
FAULT Logic Output Voltage Low	I _{SINK} = 1mA, V _{SET} = 1.4V			0.4	V	
Turn-On Time	V _{IN} = 5V, I _{OUT} = 500mA			200	μs	
Turn-Off Time	$V_{IN} = 5V$, $I_{OUT} = 500$ mA	1		20	μs	

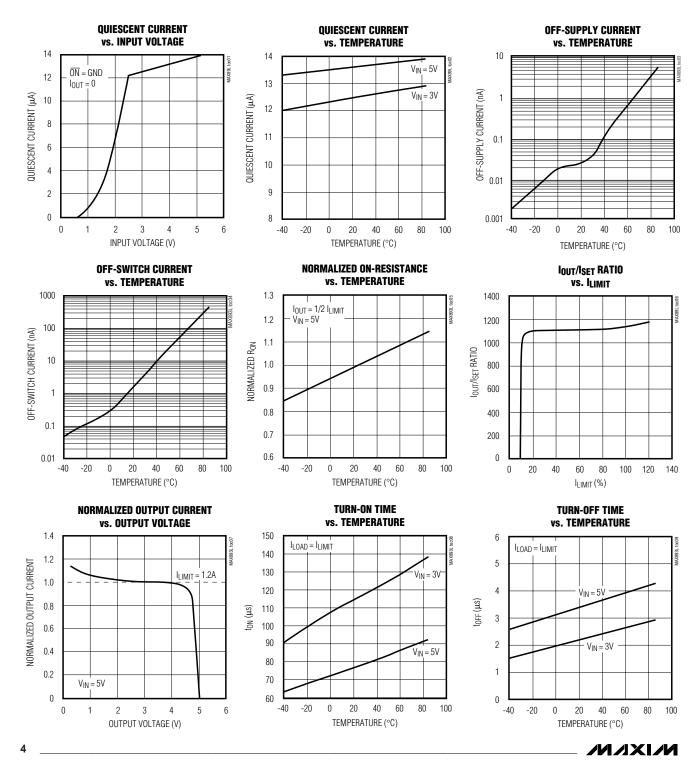
Note 1: Tested with $I_{OUT} = 100 \text{mA}$ and V_{SET} raised until $V_{IN} - V_{OUT} \ge 0.8 \text{V}$.

Note 2: Specifications to -40°C are guaranteed by design, not production tested.



Typical Operating Characteristics

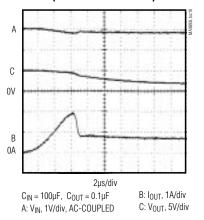
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



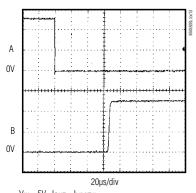
Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

OUTPUT OVERLOAD (SLOW-LOOP RESPONSE)

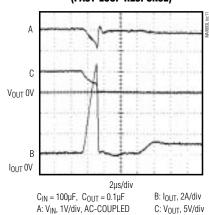


SWITCH TURN-ON TIME

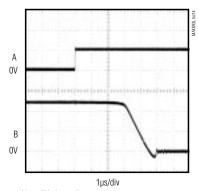


 $V_{IN} = 5V$, $I_{OUT} = I_{LIMIT/2}$ A: V_{ON} , 2V/divB: V_{OUT} , 2V/div

OUTPUT SHORT CIRCUIT (FAST-LOOP RESPONSE)



SWITCH TURN-OFF TIME



 $V_{IN} = 5V$, $I_{OUT} = I_{LIMIT/2}$ A: $V_{\overline{ON}}$, 2V/divB: V_{OUT} , 2V/div

Pin Description

PIN	NAME	FUNCTION	
1, 2	IN Input. P-channel MOSFET source. Bypass IN with a 1µF capacitor to ground.		
3	ŌN	Active-Low Switch On Input. A logic low turns the switch on.	
4	GND	Ground	
5	SET Set Current-Limit Input. A resistor from SET to ground sets the current limit for the switch. RSET = 1.34 • 10 ³ / I _{LIMIT} , where I _{LIMIT} is the desired current limit in amperes.		
6, 7	OUT Switch Output. P-channel MOSFET drain. Bypass OUT with a 0.1µF capacitor to ground.		
8	FAULT	Fault-Indicator Output. This open-drain output goes low when in current limit or when the die temperature exceeds +165°C.	

Detailed Description

The MAX893L P-channel MOSFET power switch limits output current to a programmed level. When the output current is increased beyond the programmed current limit, or 1.2A (I_{MAX}), the current also increases through the replica switch (I_{OUT} / 1080) and through R_{SET} (Figure 1). The current-limit error amplifier compares the voltage across R_{SET} to the internal 1.24V reference, and regulates the current to the programmed current limit (I_{LIMIT}).

This switch is not bidirectional; therefore, the input voltage must be higher than the output voltage.

Setting the Current Limit

The MAX893L features internal current-limiting circuitry with a maximum programmable value (I_{MAX}) of 1.2A. For best performance, set the current limit (I_{LIMIT}) between 0.2A $\leq I_{LIMIT} \leq$ 1.2A. This current limit remains in effect throughout the input supply-voltage range.

Program the current limit with a resistor (RSET) from SET to ground (Figure 2) as follows:

 $I_{SET} = I_{LIMIT} / 1080$ RSFT = 1.24V / $I_{SET} = 1.34 \cdot 10^3 / I_{LIMIT}$

where ILIMIT is the desired current limit.

Short-Circuit Protection

The MAX893L is a short-circuit protected switch. In the event of an output short circuit or a current overload condition, the current through the switch is limited by the internal current-limiting error amplifier to 1.5 • I_{LIMIT}. The short-circuit current is typically 1.8A for a programmed current limit of 1.2A. When the short-circuit condition is removed, the replica error amplifier will set the current limit back to I_{LIMIT}.

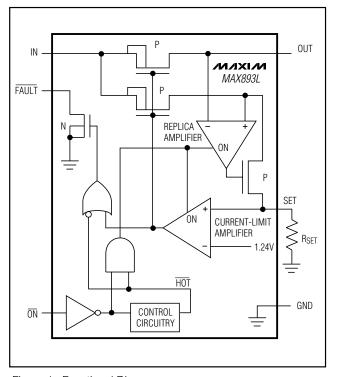


Figure 1. Functional Diagram

For a high $\Delta V_{DS}/\Delta t$ during an output short-circuit condition, the switch turns off and disconnects the input supply from the output. The current-limiting amplifier then slowly turns the switch on with the output current limited to 1.5 • I_LIMIT. When the short-circuit condition is removed, the current limit is set back to I_LIMIT. See Output Short-Circuit (Fast-Loop Response) and Output Overload (Slow-Loop Response) in the *Typical Operating Characteristics*.

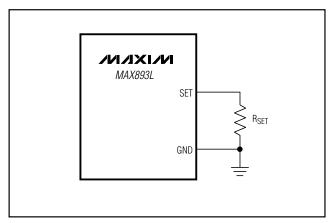


Figure 2. Setting the Current Limit

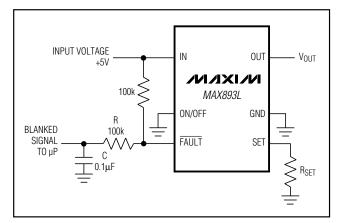


Figure 3. Fault-Blanking Circuit

Thermal Shutdown

The MAX893L features thermal shutdown. The switch turns off when the junction temperature exceeds +165°C. Once the device cools by 10°C, the switch turns back on. If the fault condition is not removed, the switch will cycle on and off, resulting in a pulsed output.

Fault Indicator

The MAX893L provides a fault output ($\overline{\text{FAULT}}$). This open-drain output goes low when in current limit or when the die temperature exceeds +165°C. A 100k Ω pull-up resistor from FAULT to IN provides a logic-control signal.

Fault Blanking

During start-up in USB applications, the MAX893L charges the relatively large USB capacitance. This may activate an unwanted fault signal if the charging current exceeds the programmed current limit. To "blank out" this start-up fault signal, add a simple lowpass RC delay circuit as shown in Figure 3. This circuit provides a 10ms delay.

Applications Information

Input Capacitor

To limit the input voltage drop during momentary output short-circuit conditions, connect a capacitor no more than 5mm from IN to GND. A 1µF ceramic capacitor will be adequate for most applications; however, higher capacitor values will further reduce the voltage drop at the input.

Output Capacitor

Connect a 0.1µF capacitor from OUT to GND to prevent inductive parasitics from pulling OUT negative during turn-off.

Layout and Thermal-Dissipation Considerations

To take full advantage of the switch-response time to output short-circuit conditions, it is very important to keep all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close to the device as possible (no more than 5mm).

Under normal operating conditions, the package can dissipate and channel heat away. Calculate the maximum power as follows:

$$P = (I_{LIMIT})^2 \cdot Ron$$

where RON is the on-resistance of the switch.

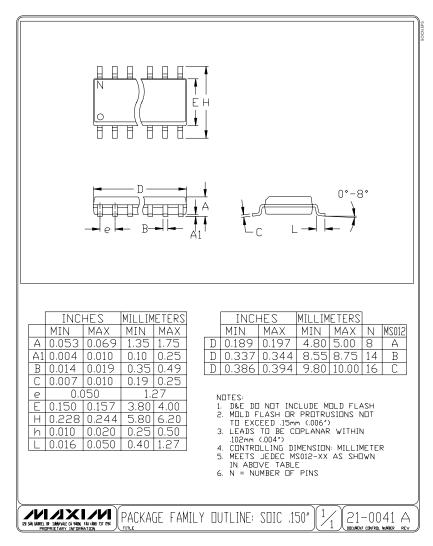
When the output is short circuited, the voltage drop across the switch equals the input supply. Hence, the power dissipated across the switch increases, as does the die temperature. If the fault condition is not removed, the thermal-shutdown protection circuitry turns the switch off until the die temperature falls by 10°C. A ground plane in contact with the device will help dissipate additional heat.

Chip Information

TRANSISTOR COUNT: 340



Package Information



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